

## RABIN & BERDO, P.C.

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March 29, 2004

PATENT, TRADEMARK AND COPYRIGHT LAW

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Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Attorney Docket No. OKI-286 D1

Re: Divisional Application Under 37 CFR 1.53(b) of Non-Provisional Parent

Application No. 10/022,268, filed December 20, 2001

Inventors: Makoto TERUI and Takahiro OKA Title: SEMICONDUCTOR PACKAGE AND METHOD OF FABRICATING SAME

Sir:

Please charge any furthe FEE ENCLOSED:\$,

- For purposes of filing a division under 37 CFR 1.53(b) of the above-identified parent application, please find attached hereto:
  - (a) Copies of the specification, claims, and abstract as originally filed in the parent application (pages 1-32);
  - (b) Copies of the drawings as originally filed in the parent application (6) sheets; Figures 1-7(c))); and
  - A copy of the inventor's Declaration and Power of Attorney as originally
- The filing fee is calculated below, based on the claims of the parent application

ease charge any fu to our Deposit Ac 18-0002	Basic Addi Total Num	c Filing tional Follower I number ber of in	Fee \$385/\$770	\$ 7 \$ \$ \$	770.00 0.00 0.00 0 770.00	
Sec.	2. 3. tion 1 ab	<ol> <li>Also attached is a Preliminary Amendment.</li> <li>The filing fee is calculated below, based on the claims of the parent applion 1 above), as modified by the Preliminary Amendment (section 2 above).</li> </ol>				
		(c)	A copy of the inventor's Declaration and Power of Att filed in the parent application (3 pages).	orney a	ıs origi	
			sheets; Figures 1-7(c))); and			

Commissioner for Patents March 29, 2004 Page 2

The filing fee, as calculated above, is attached. Should this remittance be insufficient or missing, however, please charge it (or credit any overpayment) to our Deposit Account number 18-0002.

- 4. Also attached is an Information Disclosure Statement with a PTO Form 1449.
- 5. The application is assigned to Oki Electric Industry Co., Ltd., having a mailing address at 7-12, Toranomon 1-chome, Minato-ku, Tokyo, JAPAN, by an Assignment recorded on December 20, 2001, beginning at Reel 012401, Frame 0430.
- 6. The benefit of priority of Application Number 243274/2001, filed on August 10, 2001 in Japan, is claimed under 35 USC 119. A certified copy of this priority application was filed in the above-identified patent application on December 20, 2001.
  - 7. Please send all correspondence to:

Rabin & Berdo, P.C. 1101 14<sup>th</sup> Street, N.W. Suite 500 Washington, D.C. 20005.

Respectfully Submitted,

Allen Wood

Registration No. 28,134